3PCR-05-006 ✓ ACTIVE

Buchanan | Buchanan 3 Series

TE Internal #: 1437646-9

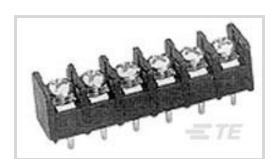
Barrier Strips, Tri-Barrier, Printed Circuit, Wire-to-Board, 5 Position,

6.35 mm [.25 in] Centerline, 1 Row, 300 V, Buchanan 3 Series

View on TE.com >



Connectors > Terminal Blocks & Strips > Barrier Strips



Barrier Strip Style: Tri-Barrier

Bottom Termination Type: Printed Circuit

Connector System: Wire-to-Board

Number of Positions: 5

Centerline (Pitch): 6.35 mm [.25 in]

Features

Product Type Features

Troduct Type reatures	
Product Type	Barrier Strip
Block Style	Open Bottom with Standoffs
Connector System	Wire-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Levels	1
Number of Positions	5
Number of Rows	1
Electrical Characteristics	
Current Rating (Max)	10 A
Voltage Rating	300 V
Body Features	
Color	Black
Barrier Strip Style	Tri-Barrier
Contact Features	
Terminal Material	Copper Alloy
Terminal Plating Finish	Bright

Tin

Terminal Plating Material



Termination Features

Mechanical Attachment

Mounting Angle	Right Angle
Screw Head Type	Combo Phil-Slot
Top Termination Type	Wire Clamp Combo Head
Mounting Insert	Without
Screw Plating Material	Zinc
Screw Material	Steel
Mounting Options	None
Mounting Ears	Without
Screw Size	M3

Housing Features

Connector Mounting Type

Housing Material	Thermoplastic
Centerline (Pitch)	6.35 mm[.25 in]

Board Mount

Dimensions

Length	33.53 mm[1.32 in]
Wire Size	$.05 - 1.3 \text{ mm}^2$

Operation/Application

Circuit Application	Power	
---------------------	-------	--

Industry Standards

Packaging Features

Packaging Quantity	300
Packaging Method	Package

Other

Comment	Other options available upon request,
	consult our Product Information Center.,
	Screws are bottomed.



Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

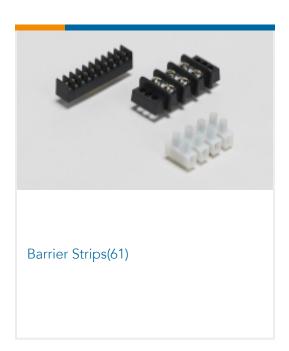
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Buchanan 3 Series





Documents

Product Drawings
3PCR-05-006=3PCR-ASSY

English

Datasheets & Catalog Pages

1-1773458-2_BARRIER_STRIPS_QUICK_REFERENCE_GUIDE

English